SCOPE:

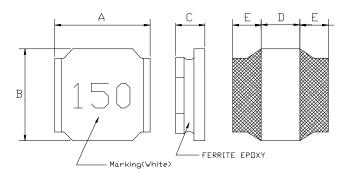
This specification applies to the Pb Free high current type SMD inductors for MNR-6045-SERIES

PRODUCT INDENTIFICATION

MNR - 6045 - 150 M

- (I) (I
- 34
- **① Product Code**
- 2 Dimensions Code
- ③ Inductance Code
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 6.0±0.3 mm

B: 6.0±0.3 mm

C: 4.5 Max. mm

D: 3.10Typ. mm

E: 1.45Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)
SRF: HP 4291B IMPEDANCE ANALYZER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature $+60^{\circ}$ C Max.
- (3)-2 Operate temperature range -40° C \sim +125 $^{\circ}$ C (Including self temp. rise)
- (3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE 1

MAGLAYERS	Inductance	Percent	L Test	SRF(MHz)	Resistance	Rated DC Current		Marking
PT/NO.	L(µH)	Tolerance	Frequency	Тур.	RDC(Ω)±30%	IDC1(A)	IDC2(A)	warking
MNR-6045-1R0□	1.0	N	100KHz/0.25V	110	14m	8.50	4.20	1R0
MNR-6045-2R2	2.2	N	100KHz/0.25V	60	21m	6.00	3.50	2R2
MNR-6045-2R3	2.3	N	100KHz/0.25V	60	21m	6.00	3.50	2R3
MNR-6045-3R0□	3.0	M,N	100KHz/0.25V	45	24m	5.00	3.20	3R0
MNR-6045-3R3	3.3	M,N	100KHz/0.25V	45	25m	4.80	3.10	3R3
MNR-6045-4R5	4.5	M,N	100KHz/0.25V	25	31m	4.00	3.00	4R5
MNR-6045-4R7□	4.7	M,N	100KHz/0.25V	25	31m	4.00	3.00	4R7
MNR-6045-6R3	6.3	M,N	100KHz/0.25V	15	38m	3.80	2.80	6R3
MNR-6045-100□	10	M,N	100KHz/0.25V	12	47m	3.00	2.50	100
MNR-6045-150	15	M,N	100KHz/0.25V	10	77m	2.30	1.90	150
MNR-6045-220	22	M,N	100KHz/0.25V	7	0.115	1.90	1.50	220
MNR-6045-470□	47	M,N	100KHz/0.25V	5	0.220	1.30	1.10	470
MNR-6045-101	100	M,N	100KHz/0.25V	3	0.500	0.80	0.70	101

^{※ □} specify the inductance tolerance,M(±20%),N(±30%)

% IDC1 : Based on inductance change (△L/Lo : drop 30% Max.) @ ambient temp. 25%

IDC2 : Based on temperature rise ($\triangle T$: 40°C Typ.) Rated DC Current : The less value whith is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		in figure 1 and a load applied unitil the figure in the arrow		
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)		
	no mechanical	PCB dimension shall the page 7/9		
	damage or elec-	F(Pressurization)		
	trical damege.	Л		
		R5 45±2 45±2 10 20 R340		
		PRESSURE ROD figure-1		
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		and when a vibration having an amplitude of 1.52mm		
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should		
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.		
	damage.	(A total of 6 hours)		
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated		
Solderability	More than 90%	over the whole of the sample before hard, the sample shall		
		then be preheated for about 2 minutes in a temperature of		
		130∼150°C and after it has been immersed to a depth 0.5mm		
		below for 3±0.2 seconds fully in molten solder M705 with		
		a temperature of 245±5℃.		
		More than 90% of the electrode sections shall be couered		
		with new solder smoothly when the sample is taken out of		
		the solder bath.		



MECHANICAL

SPECIFICATION			
There shall be no damage or problems.	Temperature profile of reflow soldering soldering (Peak temperature 260±3° 10 sec 250 Pre-heating Slow cooling (Stored at room temperature) 2 min 100 2 min or mere The specimen shall be passed through the reflow oven with the		
	150 ~ 180°C Slow cooling (Stored at room temperature)		
	2 min sec. 2 min or mere		
	no damage or		

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS		
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top		
resistance	no other	surface and the terminal.		
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.		
	problems.			
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top		
withstand	no other	surface and the terminal of this sample		
voltage	damage or			
	problems.			
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in		
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}\mathrm{C}$,and the value		
		calculated based on the value applicable in a normal		
		temperature and narmal humidity shall be △L/L20°C ≦±10%.		



ENVIROMENT CHARACTERISTICS

TEST ITEM		SPECIFICATION					
High temperature	∆L/Lo≦±5%	△L/Lo≦±5% The sample shall be left for 96±4 hours in an atmospere with					
storage		a temperature of 85±2 $^{\circ}$ C and a normal humidity.					
	There shall be	Upon completion of the measurement shall be made after the					
	no mechanical	sample has been left in a normal temperature and normal					
	damage.	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a temperati	a temperature of -25±3℃.				
	There shall be	Upon comp	letion of the test, the meas	surement shall be made			
	no mechanical	after the sa	mple has been left in a nor	mal temperature and			
	damage.	normal hun	normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%	The sample shall be subject to 5 continuos cycles, such as shown					
temperature		in the table	2 below and then it shall b	e subjected to standard			
	There shall be	atmospheri	c conditions for 1 hour, aft	er which measurement			
	no other dama-	shall be ma	shall be made.				
	ge of problems						
			table 2				
			Temperature	Duration			
		1	−25±3 °C	30 min.			
			(Themostat No.1)				
		2	Standard	No.1→No.2			
			atmospheric	NU. I→NU.Z			
		3	85±2℃	30 min.			
			(Themostat No.2)				
		4	Standard	No.2→No.1			
			atmospheric	140.2-7140.1			
Moisture storage	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in a temperature of					
	40±2°C and a humidity(RH) of 90∼95%.						
	There shall be	Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and					
	no mechanical						
	damage. normal humidity more than 1 hour.						
Test conditions :	l	1					
The	sample shall be reflow	v soldered ont	o the printed circuit board	in every test.			

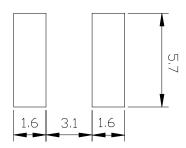


(5) LAND DIMENSION (Ref.)

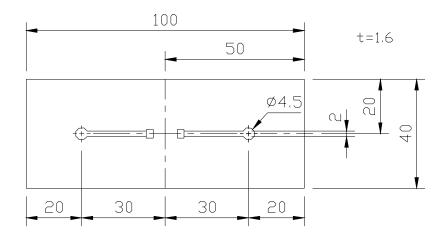
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) unit: mm



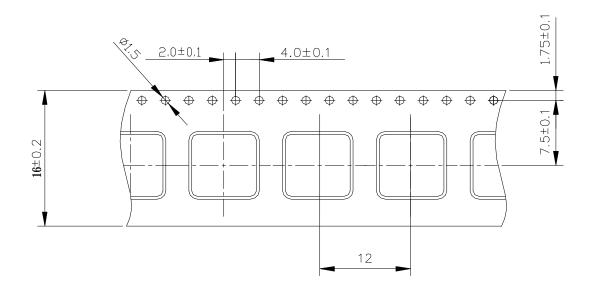
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



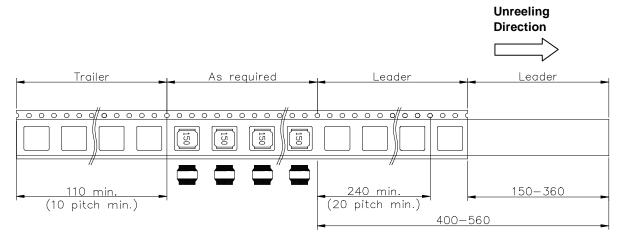


(6) PACKAGING

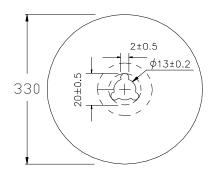
(6)-1 CARRIER TAPE DIMENSIONS (mm)

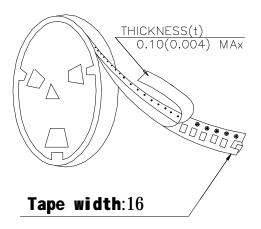


(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

1000pcs/Reel

The products are packaged so that no damage will be sustained.